U.S. Patent Application No.: Unknown

April 19, 2005 Page 5 of 9

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the

application:

LISTING OF CLAIMS:

Claims 1-4 (canceled).

Claim 5 (new): A laminated coil component comprising:

a coil conductor including a plurality of strip electrodes and via-holes for

connecting predetermined ends of the strip electrodes inside a ceramic laminate;

wherein

an axis of the coil conductor corresponds with a width direction of the ceramic

laminate, which is substantially perpendicular to both a thickness direction and a length

direction of the ceramic laminate.

Claim 6 (new): The laminated coil component according to claim 5, wherein the

laminated coil component further comprises external electrodes disposed at end regions

in the length direction on a main surface in the lamination direction of the ceramic

laminate and connected to the ends of the coil conductor.

Claim 7 (new): The laminated coil component according to claim 6, wherein the

external electrodes cover regions where the via-holes are arranged.

Claim 8 (new): The laminated coil component according to claim 6, wherein the

external electrodes are spaced from edges of the main surface of the ceramic laminate.

U.S. Patent Application No.: Unknown

April 19, 2005 Page 6 of 9

Claim 9 (new): The laminated coil component according to claim 5, wherein the

via-holes are filled with a conductive material.

Claim 10 (new): The laminated coil component according to claim 9, wherein the

conductive material is Ag paste.

Claim 11 (new): The laminated coil component according to claim 6, wherein the

external electrodes include a Ni base layer and an Au layer disposed on the Ni base

layer.

Claim 12 (new): The laminated coil component according to claim 6, wherein the

external electrodes include a Ni base layer and a Sn layer disposed on the Ni base

layer.

Claim 13 (new): The laminated coil component according to claim 6, wherein the

external electrodes include a pair of top electrodes spaced apart from one another on a

main surface of the ceramic laminate and a bottom electrode disposed directly below

the top electrodes in the ceramic laminate.

Claim 14 (new): The laminated coil component according to claim 5, wherein coil

conductor is spiral-shaped.

Claim 15 (new): A method for manufacturing a laminated coil component,

comprising the steps of:

U.S. Patent Application No.: Unknown

April 19, 2005 Page 7 of 9

laminating ceramic green sheets having a plurality of strip electrodes and via-

holes for connecting predetermined ends of the strip electrodes to form a ceramic

laminate including a coil conductor such that an axis of the coil conductor corresponds

with a width direction of the ceramic laminate, which is substantially perpendicular to

both a thickness direction and a length direction of the ceramic laminate;

forming external electrodes at end regions in the length direction on a main

surface in the lamination direction of the ceramic laminate and connected to the ends of

the coil conductor such that the external electrodes cover regions where the via-holes

are arranged; and

press-bonding and firing the laminated ceramic green sheets.

Claim 16 (new): The method for manufacturing the laminated coil component

according to claim 15, wherein the via-holes are formed by irradiating respective

ceramic green sheets of the ceramic laminate with a laser beam to form through-holes

therein, and by filling the through-holes with a conductive material.

Claim 17 (new): The method for manufacturing the laminated coil component

according to claim 16, wherein the conductive material is Ag paste.

Claim 18 (new): The method for manufacturing the laminated coil component

according to claim 15, wherein the external electrodes are formed by plating Ni as a

base layer and plating Au on the base layer.

U.S. Patent Application No.: Unknown

April 19, 2005 Page 8 of 9

Claim 19 (new): The method for manufacturing the laminated coil component according to claim 15, wherein the external electrodes are formed by plating Ni as a base layer and plating Sn on the base layer.